COMPLIANT

HALOGEN FREE

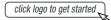


Vishay General Semiconductor

High Current Density Surface Mount Schottky Barrier Rectifiers



DESIGN SUPPORT TOOLS





| PRIMARY CHARACTERISTICS | | | | |
|--|----------------|--|--|--|
| I _{F(AV)} | 8.0 A | | | |
| V _{RRM} | 20 V, 30 V | | | |
| I _{FSM} | 150 A | | | |
| E _{AS} | 20 mJ | | | |
| V _F at I _F = 8.0 A | 0.472 V | | | |
| T _J max. | 150 °C | | | |
| Package | SMPC (TO-277A) | | | |
| Circuit configuration | Single | | | |

FEATURES

- Very low profile typical height of 1.1 mm
- · Ideal for automated placement
- Low forward voltage drop
- Low power loss, high efficiency
- · Low thermal resistance
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

TYPICAL APPLICATIONS

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

MECHANICAL DATA

Case: SMPC (TO-277A)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3_X - halogen-free, RoHS-compliant and AEC-Q101 gualified

("_X" denotes revision code e.g. A, B,....)

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

| MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted) | | | | | |
|---|-----------------------------------|-------------|--------|------|--|
| PARAMETER | SYMBOL | SS8P2L | SS8P3L | UNIT | |
| Device marking code | | S82 | S83 | | |
| Maximum repetitive peak reverse voltage | V_{RRM} | 20 | 30 | V | |
| Maximum average forward rectified current (fig. 1) | I _{F(AV)} | 8.0 | | А | |
| Peak forward surge current 10 ms single half sine-wave superimposed on rated load | I _{FSM} | 150 | | | |
| Non-repetitive avalanche energy at I _{AS} = 2 A, T _J = 25 °C | E _{AS} | 20 | | mJ | |
| Operating junction and storage temperature range | T _J , T _{STG} | -55 to +150 | | °C | |



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| ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | | |
|---|--------------------|---------------------------|-------------------------|-------|------|------|
| PARAMETER | SYMBOL | TEST CONDITIONS | | TYP. | MAX. | UNIT |
| Maximum instantaneous forward voltage | V _F (1) | $I_F = 4.0 \text{ A}$ | T _A = 25 °C | 0.447 | - | V |
| | | I _F = 8.0 A | | 0.533 | 0.57 | |
| | | I _F = 4.0 A | T _A = 125 °C | 0.357 | - | |
| | | I _F = 8.0 A | | 0.472 | 0.49 | |
| Maximum reverse current | I _{R (2)} | (2) V _R = 30 V | T _A = 25 °C | 55 | 200 | μA |
| | | | T _A = 125 °C | 24 | 35 | mA |
| Typical junction capacitance | CJ | 4.0 V, 1 MHz | | 330 | - | pF |

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

| THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | | |
|---|--------------------|--------|------|-------|--|--|
| PARAMETER | SYMBOL | SS8P2L | UNIT | | | |
| Tunical thormal registance | thermal registeres | | 0 | °C/W | | |
| Typical thermal resistance | $R_{	hetaJL}$ | 3.5 | | O/ VV | | |

Note

⁽¹⁾ Units mounted on recommended PCB 1 oz. pad layout

| ORDERING INFORMATION (Example) | | | | | | |
|--------------------------------|-----------------|------------------------|---------------|------------------------------------|--|--|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE | | |
| SS8P3L-M3/86A | 0.1 | 86A | 1500 | 7" diameter plastic tape and reel | | |
| SS8P3L-M3/87A | 0.1 | 87A | 6500 | 13" diameter plastic tape and reel | | |
| SS8P3LHM3_A/H (1) | 0.1 | Н | 1500 | 7" diameter plastic tape and reel | | |
| SS8P3LHM3_A/I (1) | 0.1 | I | 6500 | 13" diameter plastic tape and reel | | |

Note

(1) AEC-Q101 qualified

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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

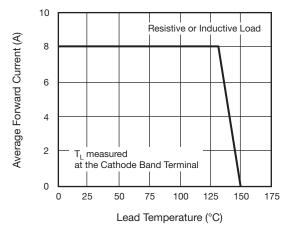


Fig. 1 - Maximum Forward Current Derating Curve

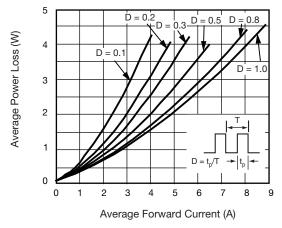


Fig. 2 - Forward Power Loss Characteristics

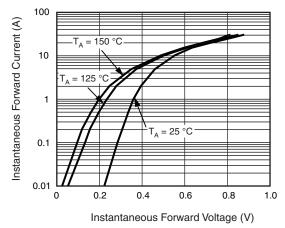


Fig. 3 - Typical Instantaneous Forward Characteristics

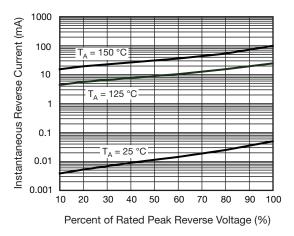


Fig. 4 - Typical Reverse Leakage Characteristics

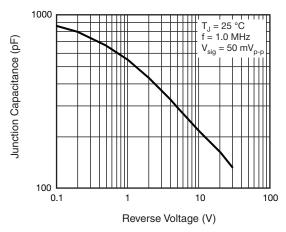


Fig. 5 - Typical Junction Capacitance

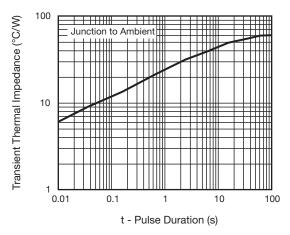
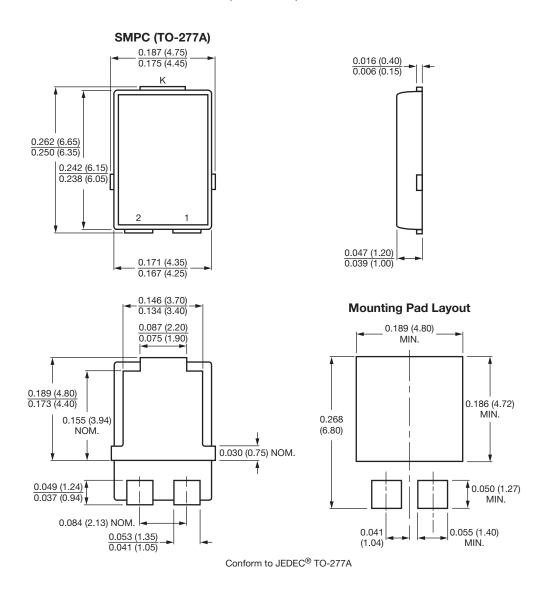


Fig. 6 - Typical Transient Thermal Impedance



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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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